■ MN102H74D, MN102H74F, MN102H74G

Туре	MN102H74D	MN102H74F	MN102H74G			
ROM (x8-bit)	64 K	96 K	128 K			
RAM (×8-bit)	4 K	4 K	4 K			
Package	LQFP100-P-1414 *Lead-free					
Minimum Instruction Execution Time	With main clock operated 83.3 ns (at 3.0 V to 3.6 V, 12 MHz)					
Interrupts	• RST pin • Watchdog • NMI pin • Timer counter 0 to 9 underflow • Timer counter 10 to 13 under/overflow • Timer counter 10 to 13 compare capture A • Timer counter 10 to 13 compare capture B • ATC ch.0 to 3 transfer finish • External 0 to 5 • Serial ch.0 to 3 transmission • Serial ch.0 to 3 reception • A/D conversion finish • USB general-purpose • USBSOF • USB end points 1 to 8					
USB Functions	 EP0 Control transfer IN/OUT (two ways) EP1 to EP8 Interrupt/Bulk/Isochronous transfe Settable to IN or OUT. Double Buffering function support 	r supported.				
Timer Counter	Timer counter 0: 8-bit × 1 (timer ou Clock sourceS Interrupt sourceT	YSCLK; XI; prescaler 0; TM0IO pin				
	Timer counter 1: 8-bit × 1 (timer ou Clock source ······· S Interrupt source ····· T	YSCLK; prescaler 0; TM1IO pin				
	Connectable Timer counters 0 to	1				
	Clock source ······ S	tput, event count, timer interrupt, A/D co YSCLK; 1/8 of SYSCLK; 1/32 of SYSCI mer counter 4 underflow; TM2IO pin imer counter 2 underflow				
		YSCLK; 1/8 of SYSCLK; 1/32 of SYSC mer counter 4 underflow; TM3IO pin	LK; timer counter 2 underflow;			
		YSCLK; 1/8 of SYSCLK; 1/32 of SYSCI mer counter 3 underflow; TM4IO pin	LK; timer counter 2 underflow;			

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	output, event count, timer interrupt)
Clock source ······	· SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 2 underflow; timer counter 3 underflow; timer counter 4 underflow; TM5IO pin
Interrupt source ·····	· Timer counter 5 underflow
(Connectable) Timer counters 2	
	output, event count, timer interrupt, serial clock generation)
	· SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 7 underflow;
	timer counter 8 underflow; TM6IO pin
Interrupt source ·····	· Timer counter 6 underflow
Timer counter 7: 8-bit \times 1 (timer	output, event count, timer interrupt, serial clock generation)
Clock source ·····	· SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 6 underflow;
	timer counter 8 underflow; TM7IO pin
Interrupt source ·····	· Timer counter 7 underflow
	output, event count, timer interrupt, serial clock generation)
Clock source ·····	· SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 6 underflow; timer counter 7 underflow; TM8IO pin
Interrupt source	· Timer counter 8 underflow
-	
	output, event count, timer interrupt) SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 6 underflow;
Clock source	timer counter 7 underflow; timer counter 8 underflow; TM9IO pin
Interrupt source ·····	· Timer counter 9 underflow
Connectable Timer counters 6	to 9
Timer counter 10: 16-bit × 1 (tim	er output, event count, input capture, PWM output, 2-phase encoder input)
Clock source ·····	· SYSCLK; 1/8 of SYSCLK; timer counter 2 or 3 underflow; 2-phase encoding of
	TM10IOA/TM10IOB pin (1x, 4x); TM10IOB pin
Interrupt source	· Timer counter 10 under/overflow; timer counter 10 compare capture A; timer counter 10 compare capture B
Times country 11, 16 hit v 1 (time	er output, event count, input capture, PWM output, 2-phase encoder input)
	· SYSCLK; 1/8 of SYSCLK; timer counter 8 or 9 underflow; 2-phase encoding of
	TM11IOA/TM11IOB pin (1x, 4x); TM11IOB pin
Interrupt source ·····	· Timer counter 11 under/overflow; timer counter 11 compare capture A;
	timer counter 11 compare capture B
	er output, event count, input capture, PWM output, 2-phase encoder input)
Clock source ·····	· SYSCLK; 1/8 of SYSCLK; timer counter 4 or 5 underflow; 2-phase encoding of
Interrupt course	TM12IOA/TM12IOB pin (1x, 4x); TM12IOB pin Timer counter 12 under/overflow; timer counter 12 compare capture A;
interrupt source	timer counter 12 compare capture B
Timer counter 13: 16-bit \times 1 (tim	er output, event count, input capture, PWM output, 2-phase encoder input)
	· SYSCLK; 1/8 of SYSCLK; timer counter 6 or 7 underflow; 2-phase encoding of
_	TM13IOA/TM13IOB pin (1x, 4x); TM13IOB pin
Interrupt source ·····	· Timer counter 13 under/overflow; timer counter 13 compare capture A;
	timer counter 13 compare capture B

Timer Counter (Continue)

See the next page for electric characteristics, pin assignment, and support tool.

Serial Interface	Serial 0: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission / reception of 7, 8-bit length) Clock source				
	Serial 1: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission / reception of 7, 8-bit length) Clock source				
	Serial 2: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission / reception of 7, 8-bit length) Clock source				
	Serial 3: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission / reception of 7, 8-bit length) Clock source				
	UART \times 2 (common use with serial 0 to 3)				
	$I^2C \times 2$ (common use with serial 0, 1; single master)				
ATC	4-ch DMA transfer enabled between memory and memory or memory and peripheral register by set interrupt factor and software activation setting Transfer unit: bytes/word Transfer mode: 1 word/burst (max. 128 K bytes) Transfer addressing: source/destination pointer fix/increment High-speed transfer enabled between USB-FIFO and internal RAM in single address mode				
I/O Pins I/O	77 • Common use : 77 (pull-up resistance specifiable)				
A/D Inputs	uts 10-bit × 8-ch. (with S/H)				
Special Ports	USB ports (D+, D-)				
Notes	4 multiply PLL built-in, generation of internal 48 MHz at external oscillation 12 MHz				
Electrical Characteristics					

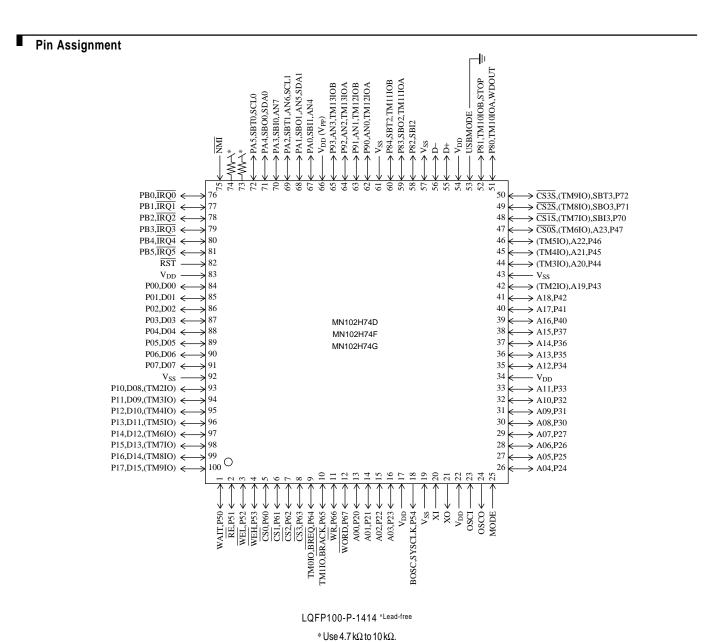
Electrical Characteristics Supply current

Parameter	Symbol	Condition		Limit		Unit
raiailletei				typ	max	Onit
Operating supply current	IDDopr	VI = VDD or VSS, output open	VI = VDD or VSS, output open $f = 12 \text{ MHz}, \text{ VDD} = 3.3 \text{ V} $ $65+10\alpha^*$			
		f = 12 MHz , $VDD = 3.3 V$			03+100.	* mA
Supply current at STOP	IDDS	Pin with pull-up resistor is open	70			
		all other input pins and Hi-Z state input/output		70	μΑ	
Supply ourrent at HALT	IDDH	pins are simultaneously applied VDD or VSS level $f = 12 \text{ MHz} \text{ , VDD} = 3.3 \text{ V, output open}$		20 : 10 or*	* mA	
Supply current at HALT				30+100.*		

 $(Ta = -20^{\circ}C \text{ to } +70^{\circ}C \text{ , VDD} = 3.3 \text{ V , VSS} = 0 \text{ V})$

* " α " depends on products. MN102H74D, MN102H74F, MN102H74G: $\alpha=0$

MN102HF74G: $\alpha = 1$



Support Tool

In-circuit Emulator	PX-ICE102H74-LQFP100-P-1414		
Flash Memory Built-in Type	Type MN102HF74G [ES (Engineering Sample) available]		
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	4 K	
	Minimum instruction execution time	83.3 ns (at 3.0 V to 3.6 V, 12 MHz)	
	Package LQFP100-P-1414 *Lead-free		

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